

### Features

- K1 IR VCSEL
- ROHS and REACH Compliant
- ESD(HBM) 8KV
- MSL 3 Qualified (J-STD 020)

# Applications

- Industrial facility applications
- Consumer Mobile
- Automotive Interior & Exterior
- 3D Sensing(TOF, Structure Light)
- Bio recognition

# Description

The INV-K1TOIR is a high-power IR VCSEL. It is a SMD type package which can be used in various applications.



# **Recommended Solder Pattern**

(Suggest Stencil t=0.12 mm)



Figure 1. INV-K1TOIR Recommended Solder Pattern

#### Note:

\*All dimensions are in millimeters.

\*Tolerance is ±0.1mm unless other specified.



# Package Dimensions in mm



Figure 2. INV-K1TOIR Package Dimensions

#### \*Note

All dimensions are in millimeters. Tolerance is  $\pm 0.1 \text{mm}$  unless other specified.



### Absolute Maximum Rating at 25°C (Note 1)

Product	Pulse Current(mA) (@1/10 duty)	V <sub>R</sub> (V) Typ.	K (mV/°C) Temperature coefficient of voltage	Max. Tj (°C ) LED junction temperature	Typ. Rjs (°C/W ) Thermal resistance, junction to solder point.	Typ. ESD (V) Electrostatic discharge threshold
INV-K1TOIR	1600	5	-1.2	110	18	8000

#### Notes

- 1. For other ambient, limited setting of current will depend on de-rating curves.
- 2. When drive on maximum current , Tj must be kept below  $110^\circ\!\mathrm{C}$
- 3. Viewing angle(2  $\theta$  1/2) ± 10°

### **Electrical Characteristics** $T_A = 25$ °C (Note 1)

Product	V⊧(V)@1200mA		Radiometric Power			Peak Wavelength			IR (µA)	View
			(mW) @1200mA			(nm) @1200mA			(V <sub>R</sub> =5V)	Angle
	min	max	min	typ	max	min	typ	max	Max	201/2
INV-K1TOIR	1.8	2.8	700		1100	840		860	10	30

#### \*Notes

- 1. Performance guaranteed only under conditions listed in above tables.
- 2. Viewing angle( $2\theta 1/2$ ) ±  $10^{\circ}$

### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



# Binning Definition (Binning@1200mA)

### Power Bin

Bin Code	Min.	Max.	Unit
P70	700	800	
P80	800	900	m\\/
P90	900	1000	mW
P100	1000	1100	

### Wavelength Bin

Bin Code	Min.	Max.	Unit
W84	840	860	nm

### Voltage Bin

Bin Code	Min.	Max.	Unit
V1	1.8	2.2	
V2	2.2	2.6	V
V3	2.6	2.8	

#### \*Notes:

1. Radiometric Power (Po) ±10%.

2. Wavelength (Wp) ±2.0nm

3. Forward voltage (V<sub>F</sub>) ±0.12V



## INV-K1TOIR K1 IR VCSEL



#### \*Notes:

Viewing angle (201/2) ± 10°



# **Ordering Information**

Orderable	Peak	Radiometric F @120	· · ·	Forward V @120	Viewing	
Part Number	Wavelength (nm)	Min	Max	Min	Max	Angle
INV-K1TOIR	840-860	700	1100	1.8	2.8	30°

# **Label Specifications**



# Inolux P/N:

INV	-	К1	Т	0		IR	-	Х	х	х	х
		Package	Orientation	Current	Lens	Color				nizec p-off	
Inolux VCSEL		K1 Package	T = Top Mount	0 = 1200mA	(Blank) = Clear	IR = 850nm					

### Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker		Year (2017	, 2018,)	Month	Date	Serial	



# **Reflow Soldering**



## **Soldering Iron**

Basic Spec is  $\leq 4$  sec. when 260°C (+10°C  $\rightarrow$  -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

### Rework

Rework should be completed within 4 second under 245°C

### Notes

- 1. Do not stress the silicone resin while it is exposed to high temperature.
- 2. The number of reflow process should not exceed 3 times.



# Packing

Dimension of Reel (Unit: mm)



### Dimension of Tape (Unit: mm)



### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing SMDs is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications;
- 4. 500pcs/Reel



### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	05-14-2019

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